

SILICON N-CHANNEL DUAL GATE MOS-FET

Depletion type field-effect transistor in a plastic X-package with source and substrate interconnected, intended for VHF applications, such as VHF television tuners, FM tuners and professional communication equipment.

This MOS-FET tetrode is protected against excessive input voltage surges by integrated back-to-back diodes between gates and source.

QUICK REFERENCE DATA

Drain-source voltage	V_{DS}	max.	20 V
Drain current	I_D	max.	20 mA
Total power dissipation up to $T_{amb} = 75^\circ\text{C}$	P_{tot}	max.	225 mW
Junction temperature	T_j	max.	150 °C
Transfer admittance at $f = 1 \text{ kHz}$ $I_D = 10 \text{ mA}; V_{DS} = 10 \text{ V}; +V_{G2-S} = 4 \text{ V}$	$ y_{fs} $	typ.	14 mS
Input capacitance at gate 1; $f = 1 \text{ MHz}$ $I_D = 10 \text{ mA}; V_{DS} = 10 \text{ V}; +V_{G2-S} = 4 \text{ V}$	C_{ig1-s}	typ.	2.1 pF
Feedback capacitance at $f = 1 \text{ MHz}$ $I_D = 10 \text{ mA}; V_{DS} = 10 \text{ V}; +V_{G2-S} = 4 \text{ V}$	C_{rs}	typ.	20 fF
Noise figure at optimum source admittance $I_D = 10 \text{ mA}; V_{DS} = 10 \text{ V}; +V_{G2-S} = 4 \text{ V}; f = 200 \text{ MHz}$	F	typ.	0.7 dB

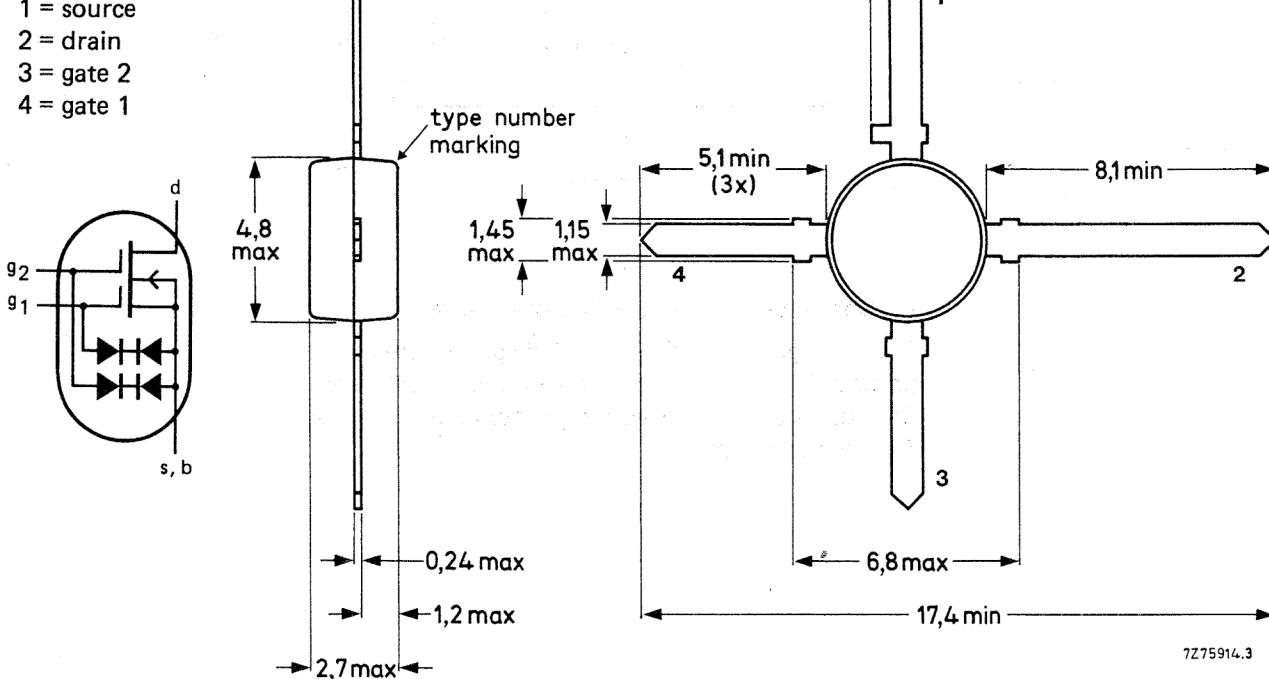
MECHANICAL DATA

Dimensions in mm

Fig.1 SOT103.

Pinning

- 1 = source
- 2 = drain
- 3 = gate 2
- 4 = gate 1



7Z5914.3

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

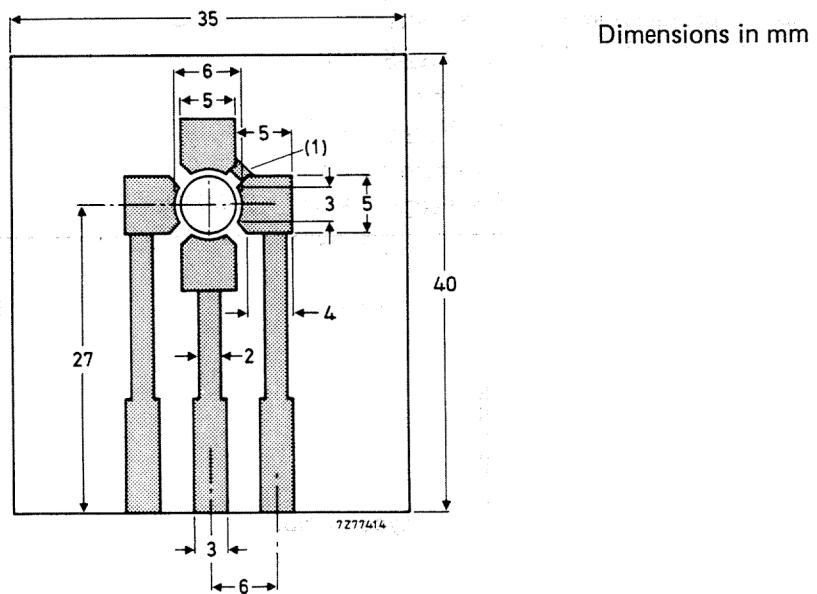
Drain-source voltage	V_{DS}	max.	20 V
Drain current (DC or average)	I_D	max.	20 mA
Gate 1 - source current	$\pm I_{G1-S}$	max.	10 mA
Gate 2 - source current	$\pm I_{G2-S}$	max.	10 mA
Total power dissipation up to $T_{amb} = 75^\circ\text{C}$	P_{tot}	max.	225 mW
Storage temperature range	T_{stg}	-	-65 to +150 °C
Junction temperature	T_j	max.	150 °C

THERMAL RESISTANCE

From junction to ambient in free air

mounted on the printed-circuit board (see Fig.2)

$$R_{th\ j-a} = 335 \text{ K/W}$$



(1) Connection made by a strip or Cu wire.

Fig. 2 Single-sided 35 μm Cu-clad epoxy fibre-glass printed-circuit board, thickness 1,5 mm. Tracks are fully tin-lead plated. Board in horizontal position for R_{th} measurement.

STATIC CHARACTERISTICS $T_j = 25^\circ\text{C}$

Gate cut-off currents

 $\pm V_{G1-S} = 5 \text{ V}; V_{G2-S} = V_{DS} = 0$
 $\pm V_{G2-S} = 5 \text{ V}; V_{G1-S} = V_{DS} = 0$
 $\pm I_{G1-SS} < 25 \text{ nA}$
 $\pm I_{G2-SS} < 25 \text{ nA}$

Gate-source breakdown voltages

 $\pm I_{G1-SS} = 10 \text{ mA}; V_{G2-S} = V_{DS} = 0$
 $\pm I_{G2-SS} = 10 \text{ mA}; V_{G1-S} = V_{DS} = 0$
 $\pm V_{(BR)G1-SS} = 6 \text{ to } 20 \text{ V}$
 $\pm V_{(BR)G2-SS} = 6 \text{ to } 20 \text{ V}$

Drain current

 $V_{DS} = 10 \text{ V}; V_{G1-S} = 0; + V_{G2-S} = 4 \text{ V}$ $I_{DSS} = 4 \text{ to } 25 \text{ mA}$

Gate-source cut-off voltages

 $I_D = 20 \mu\text{A}; V_{DS} = 10 \text{ V}; + V_{G2-S} = 4 \text{ V}$
 $I_D = 20 \mu\text{A}; V_{DS} = 10 \text{ V}; V_{G1-S} = 0$
 $-V_{(P)G1-S} < 2.5 \text{ V}$
 $-V_{(P)G2-S} < 2.5 \text{ V}$
DYNAMIC CHARACTERISTICSMeasuring conditions (common source): $I_D = 10 \text{ mA}; V_{DS} = 10 \text{ V}; + V_{G2-S} = 4 \text{ V}; T_{amb} = 25^\circ\text{C}$

Transfer admittance at $f = 1 \text{ kHz}$	$ Y_{fs} $	$> 10 \text{ mS}$ typ. 14 mS
Input capacitance at gate 1; $f = 1 \text{ MHz}$	C_{ig1-s}	typ. 2.1 pF
Input capacitance at gate 2; $f = 1 \text{ MHz}$	C_{ig2-s}	typ. 1.0 pF
Feedback capacitance at $f = 1 \text{ MHz}$	C_{rs}	typ. 20 fF
Output capacitance at $f = 1 \text{ MHz}$	C_{os}	typ. 1.1 pF
Noise figure at $f = 100 \text{ MHz}; G_S = 1 \text{ mS}; B_S = B_{S \text{ opt}}$	F	typ. 0.7 dB $< 1.7 \text{ dB}$
Noise figure at $f = 200 \text{ MHz}; G_S = 2 \text{ mS}; B_S = B_{S \text{ opt}}$	F	typ. 1.0 dB $< 2.0 \text{ dB}$
Transducer gain at $f = 100 \text{ MHz}; G_S = 1 \text{ mS}; B_S = B_{S \text{ opt}};$ $G_L = 0.5 \text{ mS}; B_L = B_{L \text{ opt}}$	G_{tr}	typ. 29 dB
Transducer gain at $f = 200 \text{ MHz}; G_S = 2 \text{ mS}; B_S = B_{S \text{ opt}};$ $G_L = 0.5 \text{ mS}; B_L = B_{L \text{ opt}}$	G_{tr}	typ. 26 dB